

HSF

NOTES:

Rated Current:1.0AMP.
Contact Resistance:20mΩ Max.
Withstand Voltage:500V AC/DC
Insulation Resistance:1000MΩ Min.
Operation Temperature:-40℃ to +105℃

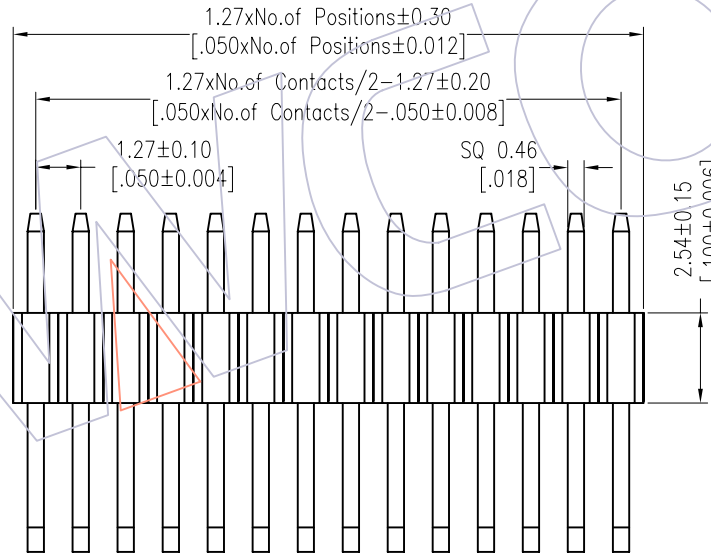
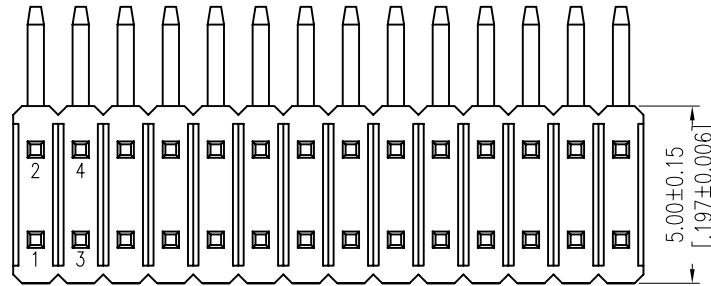
Contact Material:Brass
Contact Plating:Au or Sn Over Ni
Insulator Material:PA9T+30%G.F UL94V-0 BK

Ordering Information

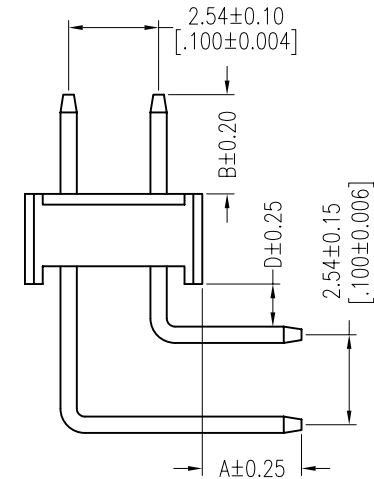
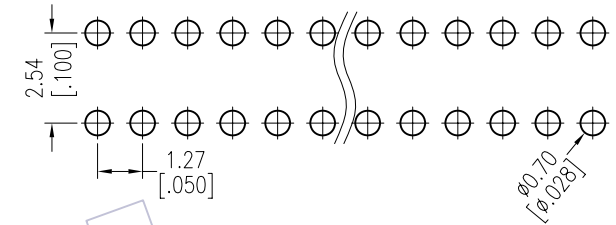
1425-12 XX XX R XXX X 1

No.of Pins Contact Plating Pin Length(short) Packing
Per Row:02~50 G0=Gold Flash L=A+B+D+3.8 A=Tray
G3=10u"Gold Standard:106=10.6 T=Tube
G4=15u"Gold 140=14.0
G5=30u"Gold
S0=Gold Flash/Tin
S3=10u"Gold/Tin
S4=15u"Gold/Tin
S5=30u"Gold/Tin

Item	Pin Length	A	D	B	Mating
Standard	10.60	2.80	1.20	2.80	2446
	14.00	3.00	1.20	6.00	2485
Alternate					



Recommended P.C.B Layout (Top Side) (PCB BOARD TOLERANCE±0.05)



					OPERATION	DRAW	DATE	SCALE	Fit	PART NO.
					X.X ±0.40	William Chen	2012.04.06	UNIT	mm	1425-12XXXXRXXXXX
					X.XX ±0.25	CHECK	DATE	SIZE	A4	TITLE:
					X.XXX ±0.15	APPROVE	DATE	SHEET	1/1	PH1.27*2.54 DUAL ROW 90° CONCAVE BENDING H=2.54
AO	2012/04/06			NEW	Angle ± 3'			PROJ.		Customer NO.
REV	DATE			MODIFICATION DESCRIPTION	DIM TOL					